

APPROVAL SHEET

RFANT Pb free Series – RoHS Compliance

MULTILAYER CERAMIC ANTENNA

Halogens Free Product

2.4 GHz ISM Band Working Frequency

5 GHz ISM Band Working Frequency

P/N: RFANT5220110A0T

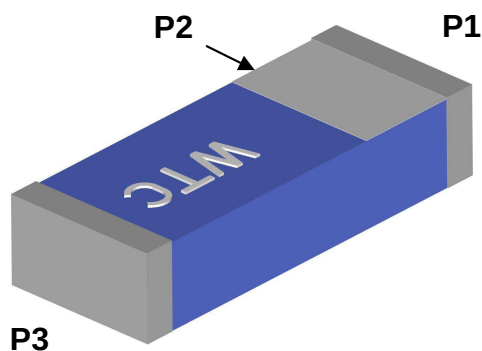
*Contents in this sheet are subject to change without prior notice.

FEATURES

1. Surface Mounted Devices with a small dimension of $5.2 \times 2.0 \times 1.1 \text{ mm}^3$ meet future miniaturization trend.
2. Embedded and LTCC (Low Temperature Co-fired Ceramic) technology is able to future integrate with system design as well as beautifying the housing of final product.
3. High Stability in Temperature / Humidity Change

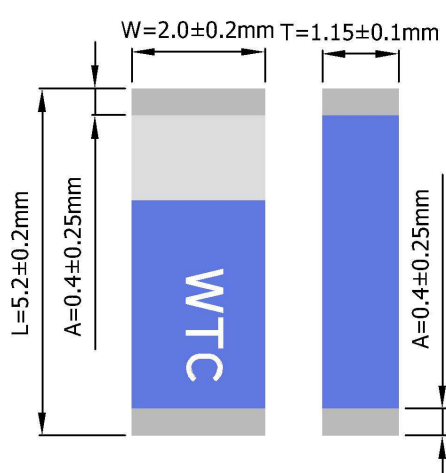
APPLICATIONS

1. Bluetooth
2. Wireless LAN
3. HormRF
4. ISM band 2.4GHz wireless applications

CONSTRUCTION

PIN	Connection
1	Feeding
2	Identification Mark
3	Soldering terminal

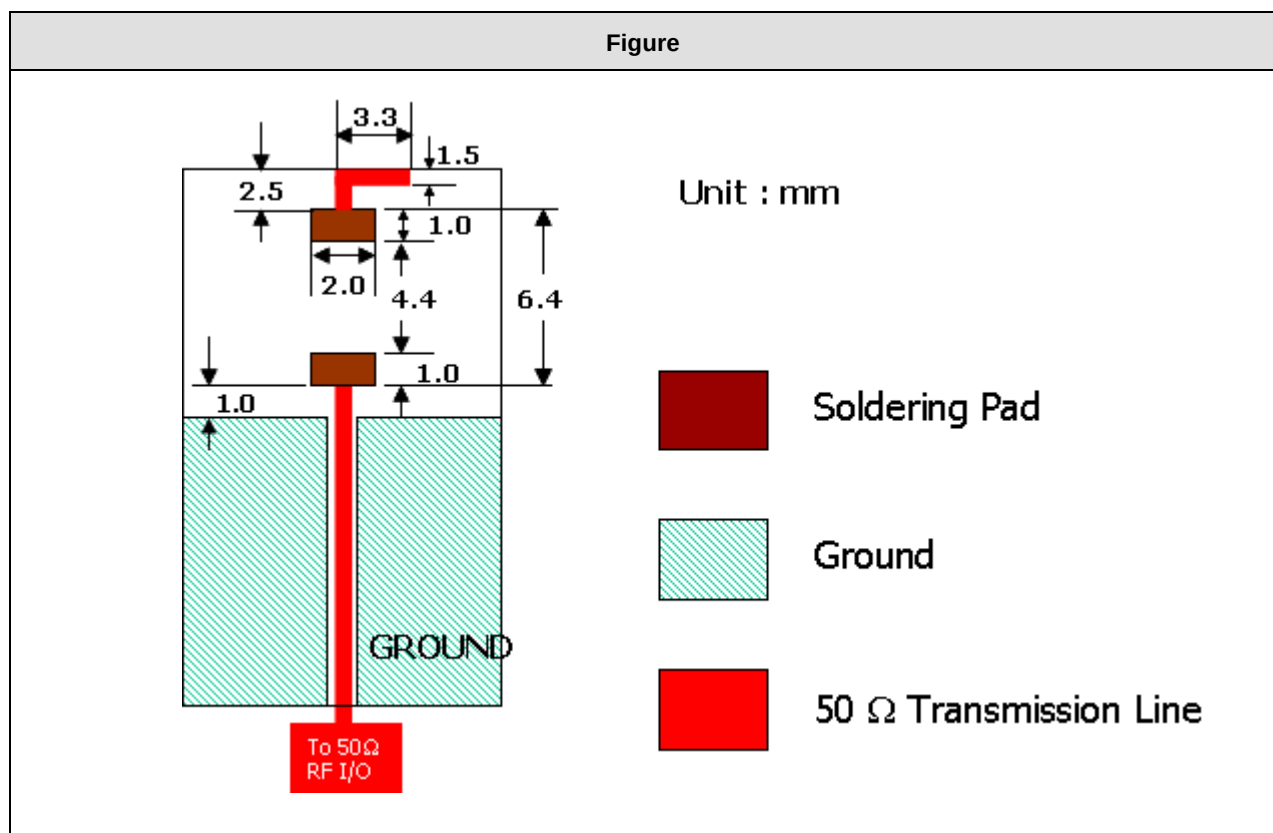
DIMENSIONS

Figure	Symbol	Dimension (mm)
	L	5.20 ± 0.20
	W	2.00 ± 0.20
	T	1.15 ± 0.10
	A	0.40 ± 0.25

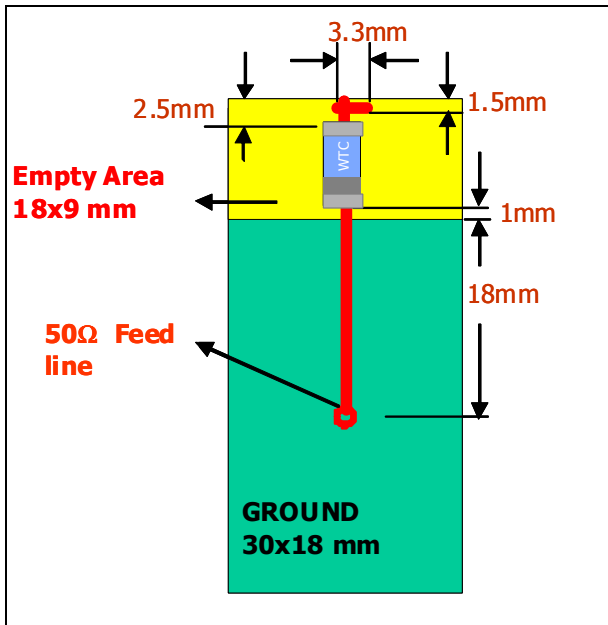
ELECTRICAL CHARACTERISTICS

RFANT5220110A0T	Specification
Working Frequency Range	2.4 GHz ~ 2.5GHz
Gain	2 dB (Typical)
VSWR	2 max.
Polarization	Linear
Azimuth Beamwidth	Omni-directional
Impedance	50Ω
Rated Power (max.)	3 Watts
Maximum Input Power	5 Watts for 5 minutes
Operation Temperature	-40°C ~ +85°C

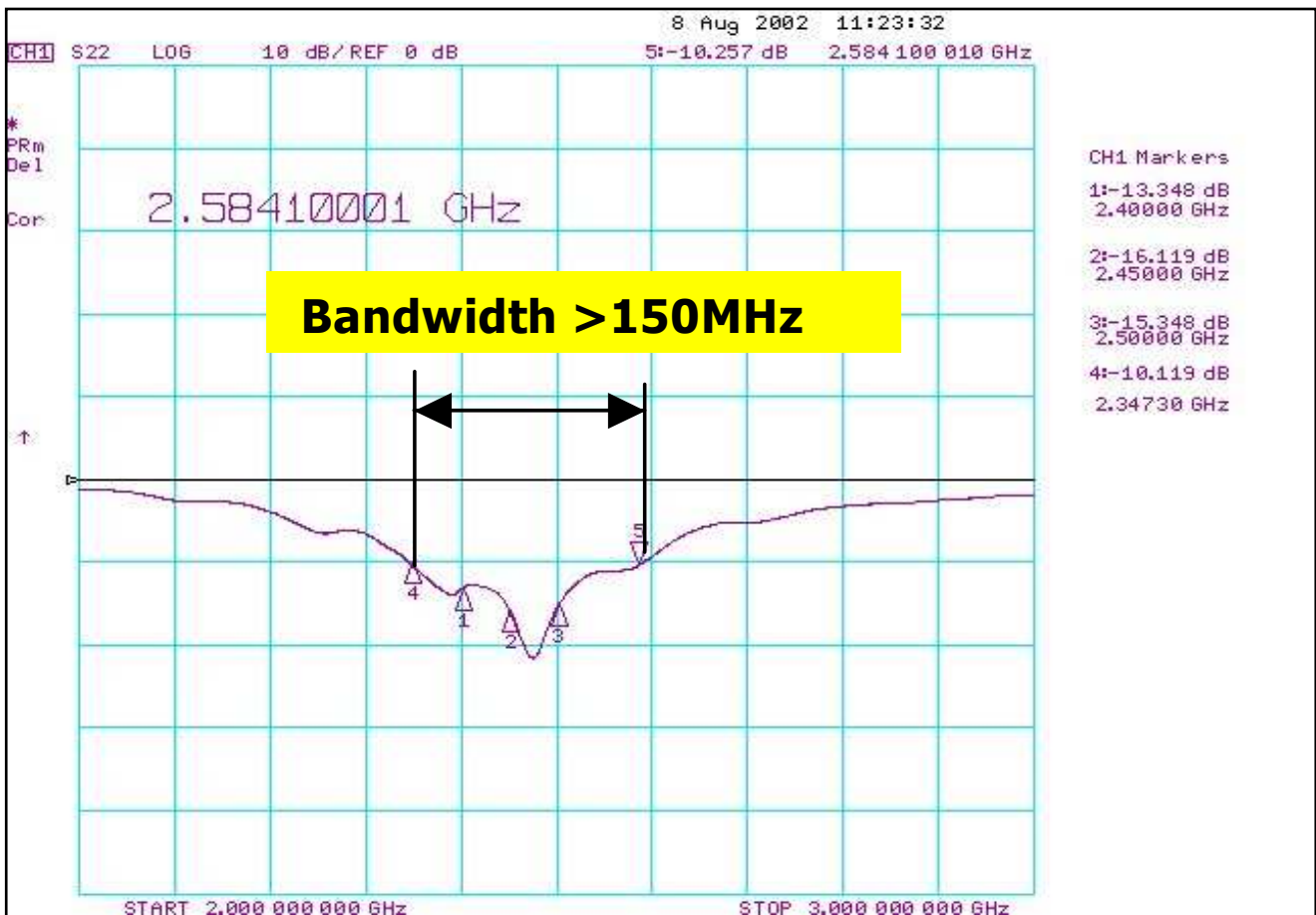
Remark: The specification is defined based on the test board dimension as in below

SOLDER LAND PATTERN DESIGN

Antenna on Test Board (FR4 Thickness 0.8mm)

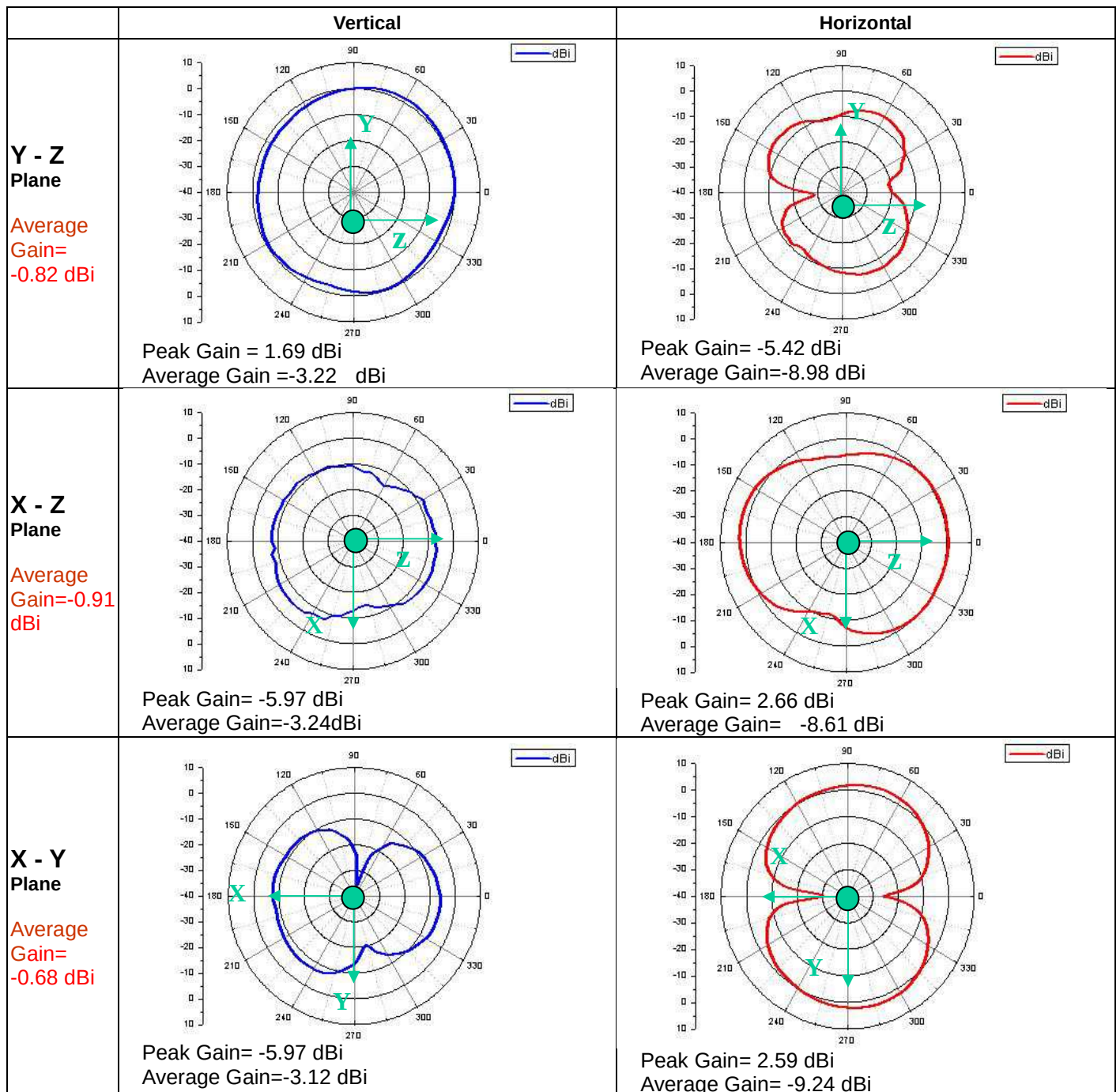
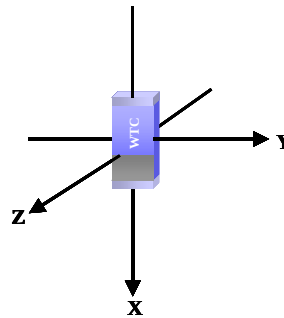
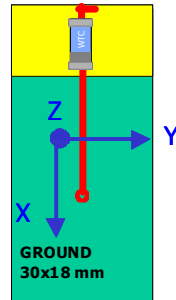


Antenna S11 on Test Board



RADIATION PATTERN

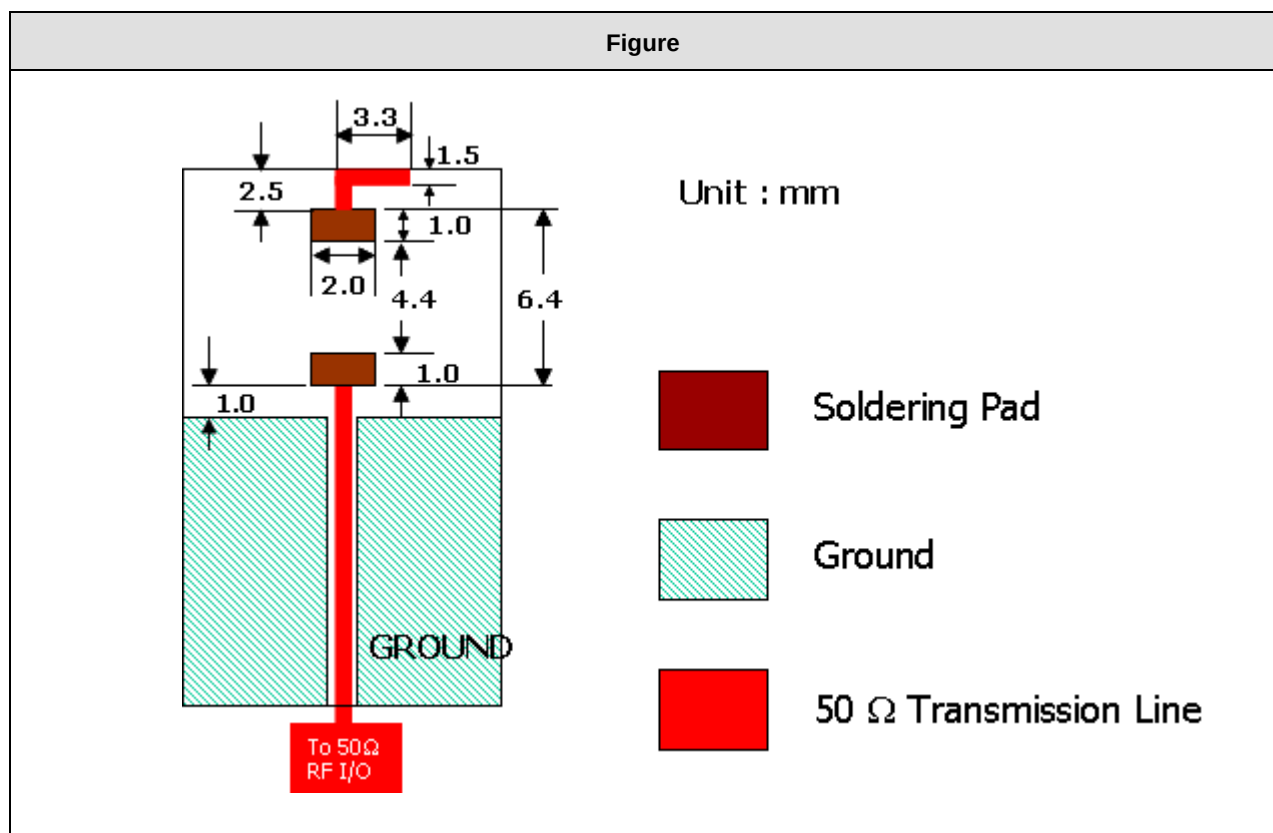
Radiation Pattern and Gain were dependent on measurement board design. The specification of RFANT5220110A0T antenna was measured based on the PCB size and installation position as shown in the below figure Test Board



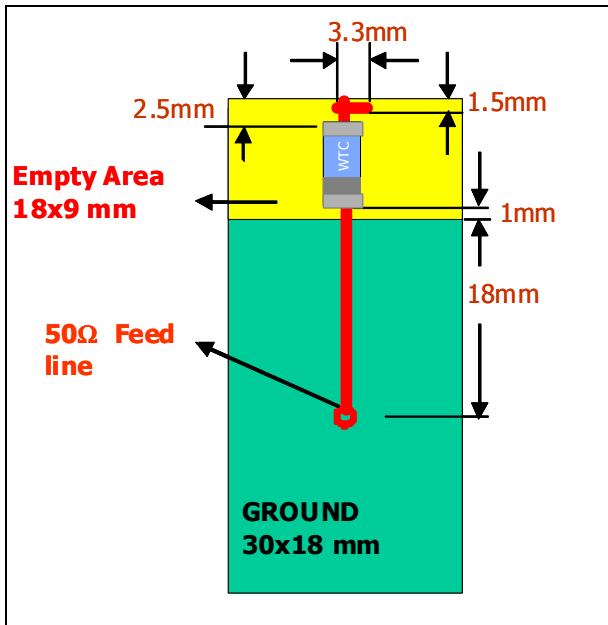
ELECTRICAL CHARACTERISTICS

RFANT5220110A0T	Specification
Working Frequency Range	5.15 GHz~ 5.85GHz
Gain	4 dB (Typical)
VSWR	2 max.
Polarization	Linear
Azimuth Beamwidth Omni-directional	
Impedance	50Ω
Rated Power (max.)	3 Watts
Maximum Input Power	5 Watts for 5 minutes
Operation Temperature	-40°C ~ +85°C

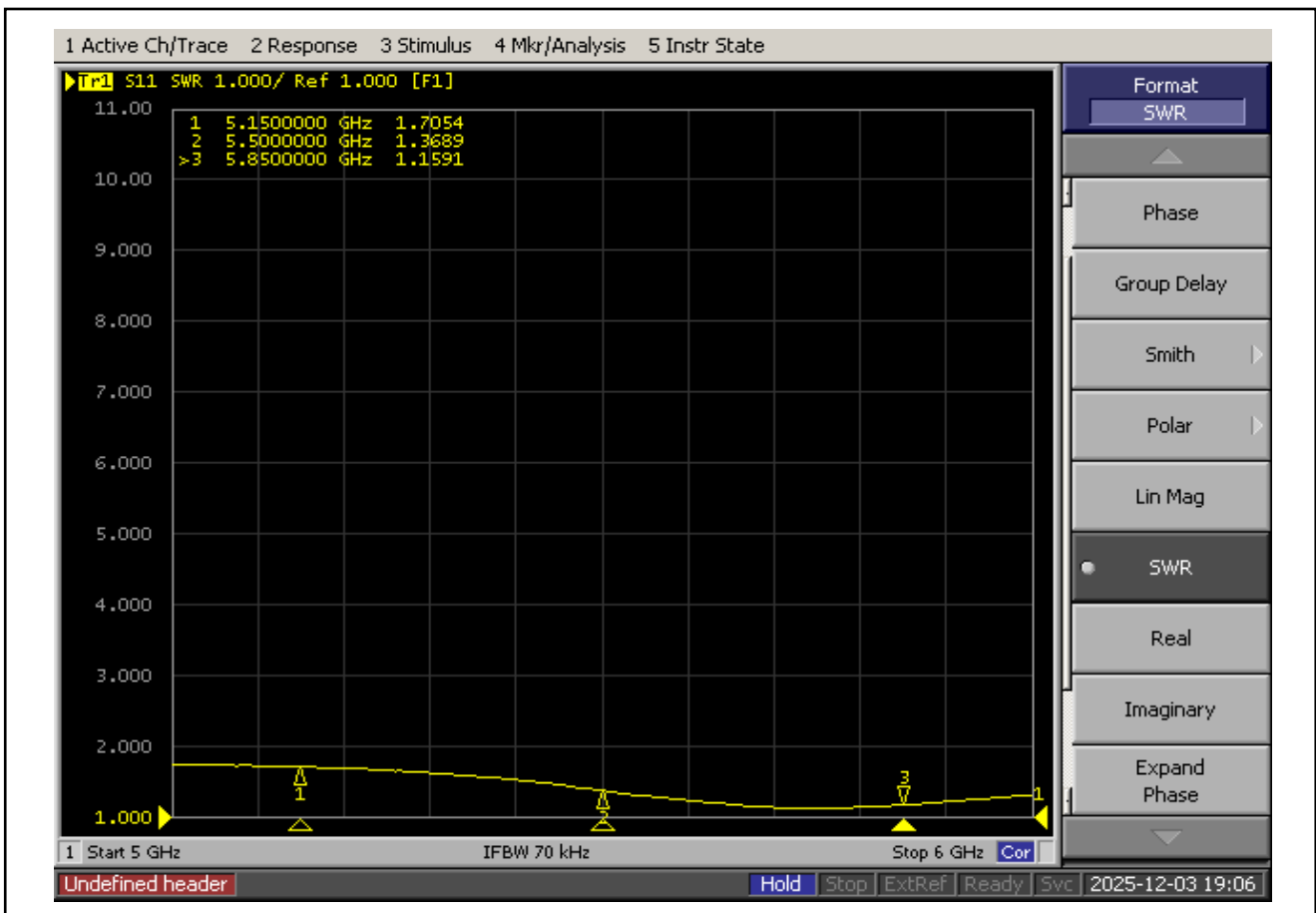
Remark: The specification is defined based on the test board dimension as in below

SOLDER LAND PATTERN DESIGN

Antenna on Test Board (FR4 Thickness 0.8mm)

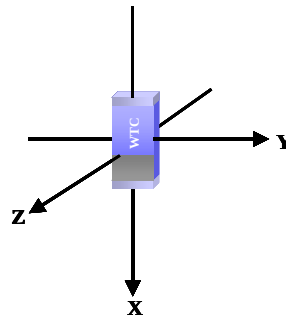
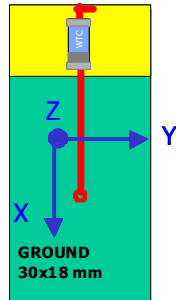


Antenna S11 on Test Board

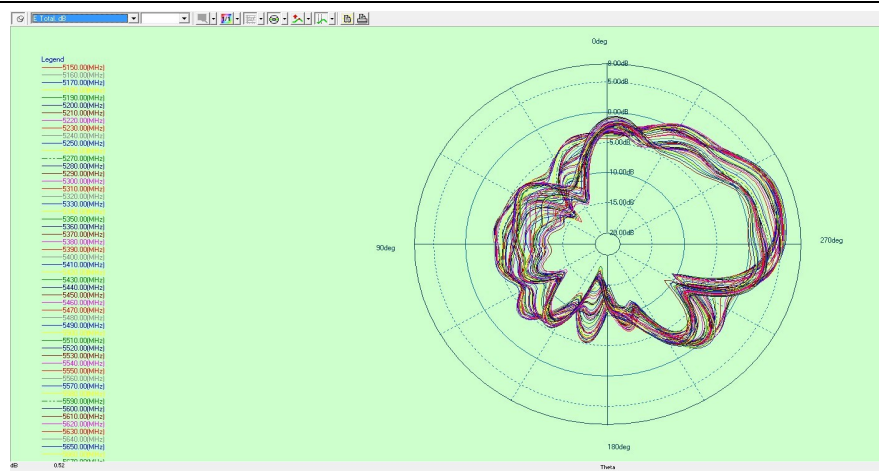


RADIATION PATTERN

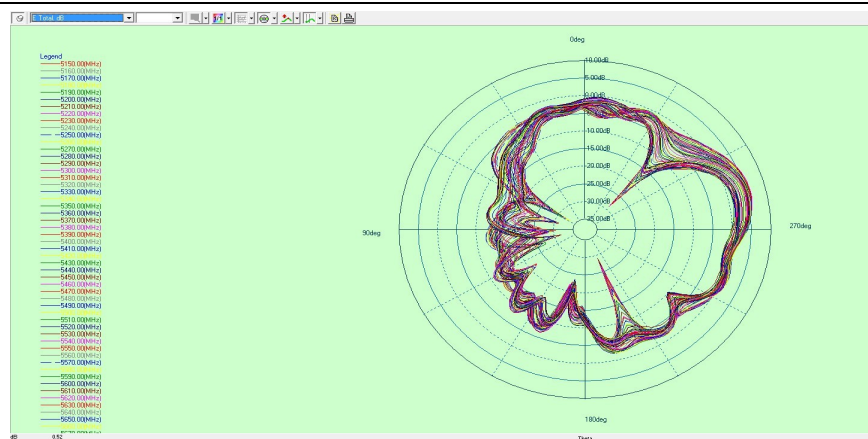
Radiation Pattern and Gain were dependent on measurement board design. The specification of RFANT5220110A0T antenna was measured based on the PCB size and installation position as shown in the below figure Test Board



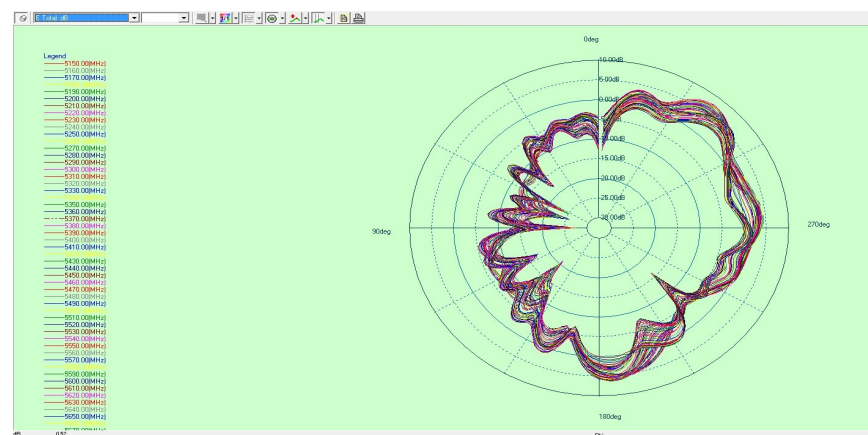
**Y - Z
Plane**



**X - Z
Plane**



**X - Y
Plane**



Frequency	Gain (dBi)	Efficiency(%)	方向性系数		Frequency	Gain (dBi)	Efficiency(%)	方向性系数
5150MHz	7.41	64%	9.34		5510MHz	5.52	48%	8.69
5160MHz	7.82	68%	9.47		5520MHz	5.32	46%	8.73
5170MHz	7.68	68%	9.34		5530MHz	5.38	45%	8.82
5180MHz	7.85	70%	9.39		5540MHz	5.30	44%	8.83
5190MHz	8.11	72%	9.52		5550MHz	4.87	42%	8.63
5200MHz	8.19	74%	9.51		5560MHz	4.18	37%	8.50
5210MHz	8.16	75%	9.43		5570MHz	4.12	35%	8.65
5220MHz	8.22	75%	9.47		5580MHz	4.12	35%	8.67
5230MHz	7.80	70%	9.32		5590MHz	3.84	34%	8.53
5240MHz	7.18	64%	9.09		5600MHz	3.51	32%	8.48
5250MHz	7.17	64%	9.10		5610MHz	3.61	32%	8.51
5260MHz	7.49	66%	9.27		5620MHz	3.59	33%	8.40
5270MHz	7.38	66%	9.21		5630MHz	3.46	33%	8.25
5280MHz	6.87	61%	8.99		5640MHz	3.49	34%	8.22
5290MHz	6.85	61%	8.96		5650MHz	3.82	36%	8.29
5300MHz	6.87	62%	8.95		5660MHz	3.85	36%	8.30
5310MHz	6.63	61%	8.76		5670MHz	3.76	35%	8.32
5320MHz	6.41	60%	8.65		5680MHz	4.21	37%	8.55
5330MHz	6.35	59%	8.67		5690MHz	4.72	41%	8.63
5340MHz	5.96	56%	8.44		5700MHz	4.79	41%	8.66
5350MHz	5.59	55%	8.18		5710MHz	4.87	41%	8.76
5360MHz	5.74	56%	8.26		5720MHz	5.45	45%	8.96
5370MHz	6.14	58%	8.48		5730MHz	5.90	49%	9.01
5380MHz	5.96	57%	8.39		5740MHz	6.08	51%	8.98
5390MHz	6.00	58%	8.39		5750MHz	6.18	52%	9.02
5400MHz	6.37	62%	8.43		5760MHz	6.39	54%	9.06
5410MHz	6.58	65%	8.47		5770MHz	6.15	53%	8.94
5420MHz	6.47	63%	8.49		5780MHz	5.98	50%	8.97
5430MHz	6.44	61%	8.56		5790MHz	6.27	51%	9.19
5440MHz	6.29	59%	8.57		5800MHz	6.34	52%	9.22
5450MHz	6.20	58%	8.53		5810MHz	6.09	50%	9.14
5460MHz	6.09	57%	8.52		5820MHz	6.02	48%	9.23
5470MHz	6.01	55%	8.58		5830MHz	6.31	49%	9.38
5480MHz	5.81	53%	8.59		5840MHz	6.20	49%	9.31
5490MHz	5.71	52%	8.57		5850MHz	5.80	46%	9.21
5500MHz	5.66	50%	8.64					

RELIABILITY TEST

Test item	Test condition / Test method	Specification
Solderability JIS C 0050-4.6 JESD22-B102D	*Solder bath temperature : $235 \pm 5^{\circ}\text{C}$ *Immersion time : 2 ± 0.5 sec Solder : Sn3Ag0.5Cu for lead-free	At least 95% of a surface of each terminal electrode must be covered by fresh solder.
Leaching (Resistance to dissolution of metallization) IEC 60068-2-58	*Solder bath temperature : $260 \pm 5^{\circ}\text{C}$ *Leaching immersion time : 30 ± 0.5 sec Solder : SN63A	Loss of metallization on the edges of each electrode shall not exceed 25%.
Resistance to soldering heat JIS C 0050-5.4	*Preheating temperature : $120 \sim 150^{\circ}\text{C}$, 1 minute. *Solder temperature : $270 \pm 5^{\circ}\text{C}$ *Immersion time : 10 ± 1 sec Solder : Sn3Ag0.5Cu for lead-free Measurement to be made after keeping at room temperature for 24 ± 2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within $-40 \sim 85^{\circ}\text{C}$. Loss of metallization on the edges of each electrode shall not exceed 25%.
Drop Test JIS C 0044 Customer's specification.	*Height : 75 cm *Test Surface : Rigid surface of concrete or steel. *Times : 6 surfaces for each units ; 2 times for each side.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within $-40 \sim 85^{\circ}\text{C}$.
Vibration JIS C 0040	*Frequency : 10Hz~55Hz~10Hz(1min) *Total amplitude : 1.5mm *Test times : 6hrs.(Two hrs each in three mutually perpendicular directions)	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within $-40 \sim 85^{\circ}\text{C}$.
Adhesive Strength of Termination JIS C 0051- 7.4.3	*Pressurizing force : 5N(≤ 0603) ; 10N(>0603) *Test time : 10 ± 1 sec	No remarkable damage or removal of the termination.
Bending test JIS C 0051- 7.4.1	The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second until the deflection becomes 1mm/s and then pressure shall be maintained for 5 ± 1 sec. Measurement to be made after keeping at room temperature for 24 ± 2 hours	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within $-40 \sim 85^{\circ}\text{C}$.

Temperature cycle JIS C 0025	1. 30±3 minutes at -40°C±3°C, 2. 10~15 minutes at room temperature, 3. 30±3 minutes at +85°C±3°C, 4. 10~15 minutes at room temperature, Total 100 continuous cycles Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
High temperature JIS C 0021	*Temperature : 85°C±2°C *Test duration : 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
Humidity (steady conditions) JIS C 0022	*Humidity : 90% to 95% R.H. *Temperature : 40±2°C *Time : 1000+24/-0 hrs. Measurement to be made after keeping at room temperature for 24±2 hrs ※ 500hrs measuring the first data then 1000hrs data	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
Low temperature JIS C 0020	*Temperature : -40°C±2°C *Test duration : 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.

SOLDERING CONDITION

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2

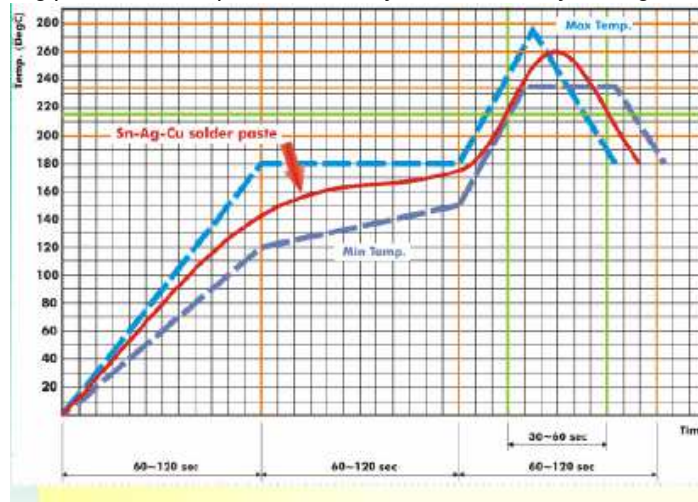


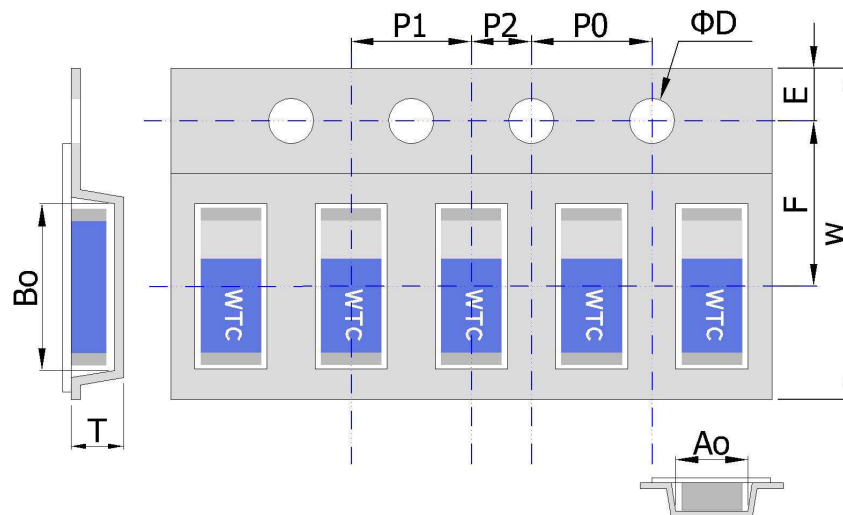
Fig 2. Infrared soldering profile

ORDERING CODE

RF	ANT	522011	0	A	0	T
Walsin RF device	Product code ANT : Antenna	Dimension code Per 2 digits of Length, Width, Thickness : e.g. : 522011 = Length 52, Width 20, Thickness 11	Unit of dimension 0 : 0.1 mm 1 : 1.0 mm	Application A : 2.4GHZ ISM Band	Specification Design Code	Packing T : 7" Reeled

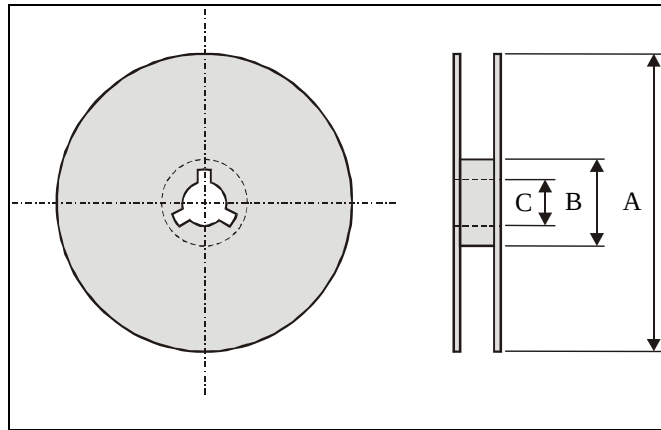
Minimum Ordering Quantity: 2000 pcs per reel.

PACKAGING



Plastic Tape specifications (unit :mm)

Index	Ao	Bo	ΦD	T	W
Dimension (mm)	2.40 ± 0.10	5.50 ± 0.10	1.55 ± 0.05	1.20 ± 0.10	12.0 ± 0.10
Index	E	F	Po	P1	P2
Dimension (mm)	1.75 ± 0.10	5.50 ± 0.10	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.10

Reel dimensions

Index	A	B	C
Dimension (mm)	Φ178	Φ60.0	Φ13.5

Typing Quantity: 2000 pieces per 7" reel

CAUTION OF HANDLING**Limitation of Applications**

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

Storage condition

- (1) Products should be used in 6 months from the day of WAL SIN outgoing inspection, which can be confirmed.
- (2) Storage environment condition.
 - Products should be storage in the warehouse on the following conditions.
 - Temperature : -10 to +40°C
 - Humidity : 30 to 70% relative humidity
 - Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
 - Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
 - Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
 - Products should be storage under the airtight packaged condition.